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	Application Number		10585275	
	Filing Date		2006-07-05	
INFORMATION DISCLOSURE	First Named Inventor Nancy		cy Dean	
STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Art Unit		2835	
(Not for Submission and or or N 1.55)	Examiner Name Unknown		nown	
	Attorney Docket Numb	er H0005430.75230 USA -4018		

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INFORMATION DISCLOSURE	First Named Inventor Nand		ancy Dean	
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